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RECORDATION FORM COVER SHEET

U.S. DEPARTMENT OF COMMERCE  
Patent and Trademark Office

Docket No.: 075820-0037

PATENTS ONLY

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

## 1. Name of Conveying Party(ies)

Jang Hoon LEE, Je Choon RYOO, Jeng Hong OH, Eui Soo  
KIM, Jong Han OHAdditional name(s) of conveying party(ies) attached? ☐ Yes ☐ No

## 3. Nature of Conveyance/Execution Date(s)

Execution Date(s): May 7, 2007, April 27, 2007, April 27,  
2007, April 27, 2007, April 27, 2007  
(Respectively)

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Joint Research Agreement  
☐ Government Interest Assignment  
☐ Executive Order 9424, Confirmatory License  
☐ Other

## 2. Name and address of receiving party(ies)

Name: SAMSUNG CORNING CO., LTD.

Internal Address:

Address: 472, Sin-dong, Yeongtong-gu, Suwon-si,  
Gyeonggi-do 443-732, Republic of Korea

11/808446

Additional name(s) & address(es) attached? ☐ Yes ☐ No

## 4. Application or patent number(s):

A. Patent Application No(s).

☒ This document is being filed together with a new application

B. Patent No(s).

Additional numbers attached? ☐ Yes ☐ No

## 5. Name and address to whom correspondence concerning document should be mailed:

Name: MCDERMOTT WILL &amp; EMERY LLP

Internal Address:

Street Address: 600 13th Street, N.W.

City: Washington State: D. C. Zip: 20005-3096

Phone Number: 202.756.8000

Fax Number: 202.756.8087

Email Address:

## 6. Total number of applications and patents involved: 1

## 7. Total fee (37 CFR 1.21(h) &amp; 3.41) \$40.00

- ☐ Authorized to be charged by credit card  
☒ Authorized to be charged to deposit account  
☐ Enclosed  
☐ None required (government interest not affecting title)nt

## 8. Payment Information:

- a. Credit Card Last 4 Numbers \_\_\_\_\_  
Expiration Date \_\_\_\_\_  
b. Deposit Account Number 500417  
Authorized User Name \_\_\_\_\_

## 9. Signature.

Stephen A. Becker, 26,527

*Bernard P. Cobb* (Reg. No. 46,429)

June 11, 2007

Name and Registration No. of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments and documents: 2

OMB No. 0651-0027 (exp. 6/30/2008)

PATENT  
REEL: 019460 FRAME: 0107

(SAB)

Docket No.: \_\_\_\_\_

**ASSIGNMENT**

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

(1) <u>Jang Hoon LEE</u>	(4) <u>Eui Soo KIM</u>
(2) <u>Je Choon RYOO</u>	(5) <u>Jong Han OH</u>
(3) <u>Jeong Hong OH</u>	(6) _____

who have made a certain new and useful invention, hereby sell, assign and transfer unto

SAMSUNG CORNING CO., LTD., a Korean corporation, having a place of business at  
472, Sin-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do 443-732, Republic of Korea

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

COATING LAYER FOR BLOCKING EMI, OPTICAL FILTER INCLUDING THE SAME,  
AND DISPLAY APPARATUS INCLUDING THE SAME

(a) for which an application for United States Letters Patent was filed on \_\_\_\_\_  
and identified by United States Serial No. \_\_\_\_\_; or

(b) for which an application for United States Letters Patent was executed or  
\_\_\_\_\_

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

INVENTORS	DATE SIGNED
1) <u>Jang Hoon Lee</u> Name: Jang Hoon LEE	<u>May 1, 2007</u>
2) <u>Je Choon RYOO</u> Name: Je Choon RYOO	<u>April 27, 2007</u>
3) <u>Jeong Hong OH</u> Name: Jeong Hong OH	<u>April 27, 2007</u>
4) <u>Eui Soo KIM</u> Name: Eui Soo KIM	<u>April 27, 2007</u>
5) <u>JONG HAN OH</u> Name: Jong Han OH	<u>April 27, 2007</u>
6) _____ Name: _____	_____

PATENT

RECORDED: 06/11/2007

REEL: 019460 FRAME: 0108